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**MICROCHIP**

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**PIC16(L)F1934/6/7**  
**Data Sheet**

28/40/44-Pin Flash-Based, 8-Bit  
CMOS Microcontrollers with  
LCD Driver and nanoWatt XLP Technology

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== ISO/TS 16949:2002 ==**

## 28/40/44-Pin Flash-Based, 8-Bit CMOS Microcontrollers with LCD Driver with nanoWatt XLP Technology

### Devices Included In This Data Sheet:

- PIC16F1934
- PIC16LF1934
- PIC16F1936
- PIC16LF1936
- PIC16F1937
- PIC16LF1937

### Other PIC16(L)F193X Devices Available:

- PIC16(L)F1933 (DS41575)
- PIC16(L)F1938/9 (DS41574)

**Note:** PIC16(L)F193X devices referred to in this data sheet apply to PIC16(L)F1934/6/7.

### High-Performance RISC CPU:

- Only 49 Instructions to Learn:
  - All single-cycle instructions except branches
- Operating Speed:
  - DC – 32 MHz oscillator/clock input
  - DC – 125 ns instruction cycle
- Up to 16K x 14 Words of Flash Program Memory
- Up to 1024 Bytes of Data Memory (RAM)
- Interrupt Capability with Automatic Context Saving
- 16-Level Deep Hardware Stack
- Direct, Indirect and Relative Addressing modes
- Processor Read Access to Program Memory
- Pinout Compatible to other 28/40/44-pin PIC16CXXX and PIC16FXXX Microcontrollers

### Special Microcontroller Features:

- Precision Internal Oscillator:
  - Factory calibrated to  $\pm 1\%$ , typical
  - Software selectable frequency range from 32 MHz to 31 kHz
- Power-Saving Sleep mode
- Power-on Reset (POR)
- Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Brown-out Reset (BOR)
  - Selectable between two trip points
  - Disable in Sleep option
- Multiplexed Master Clear with Pull-up/Input Pin
- Programmable Code Protection
- High Endurance Flash/EEPROM cell:
  - 100,000 write Flash endurance
  - 1,000,000 write EEPROM endurance
  - Flash/Data EEPROM retention: > 40 years
- Wide Operating Voltage Range:
  - 1.8V-5.5V (PIC16F193X)
  - 1.8V-3.6V (PIC16LF193X)

### PIC16LF193X Low-Power Features:

- Standby Current:
  - 60 nA @ 1.8V, typical
- Operating Current:
  - 7.0  $\mu$ A @ 32 kHz, 1.8V, typical (PIC16LF193X)
  - 150  $\mu$ A @ 1 MHz, 1.8V, typical (PIC16LF193X)
- Timer1 Oscillator Current:
  - 600 nA @ 32 kHz, 1.8V, typical
- Low-Power Watchdog Timer Current:
  - 500 nA @ 1.8V, typical (PIC16LF193X)

### Peripheral Features:

- Up to 35 I/O Pins and 1 Input-only Pin:
  - High-current source/sink for direct LED drive
  - Individually programmable interrupt-on-pin change pins
  - Individually programmable weak pull-ups
- Integrated LCD Controller:
  - Up to 96 segments
  - Variable clock input
  - Contrast control
  - Internal voltage reference selections
- Capacitive Sensing module (mTouch™)
  - Up to 16 selectable channels
- A/D Converter:
  - 10-bit resolution and up to 14 channels
  - Selectable 1.024/2.048/4.096V voltage reference
- Timer0: 8-Bit Timer/Counter with 8-Bit Programmable Prescaler
- Enhanced Timer1
  - Dedicated low-power 32 kHz oscillator driver
  - 16-bit timer/counter with prescaler
  - External Gate Input mode with toggle and single shot modes
  - Interrupt-on-gate completion
- Timer2, 4, 6: 8-Bit Timer/Counter with 8-Bit Period Register, Prescaler and Postscaler
- Two Capture, Compare, PWM modules (CCP)
  - 16-bit Capture, max. resolution 125 ns
  - 16-bit Compare, max. resolution 125 ns
  - 10-bit PWM, max. frequency 31.25 kHz
- Three Enhanced Capture, Compare, PWM modules (ECCP)
  - 3 PWM time-base options
  - Auto-shutdown and auto-restart
  - PWM steering
  - Programmable dead-band delay

# PIC16(L)F1934/6/7

## Peripheral Features (Continued):

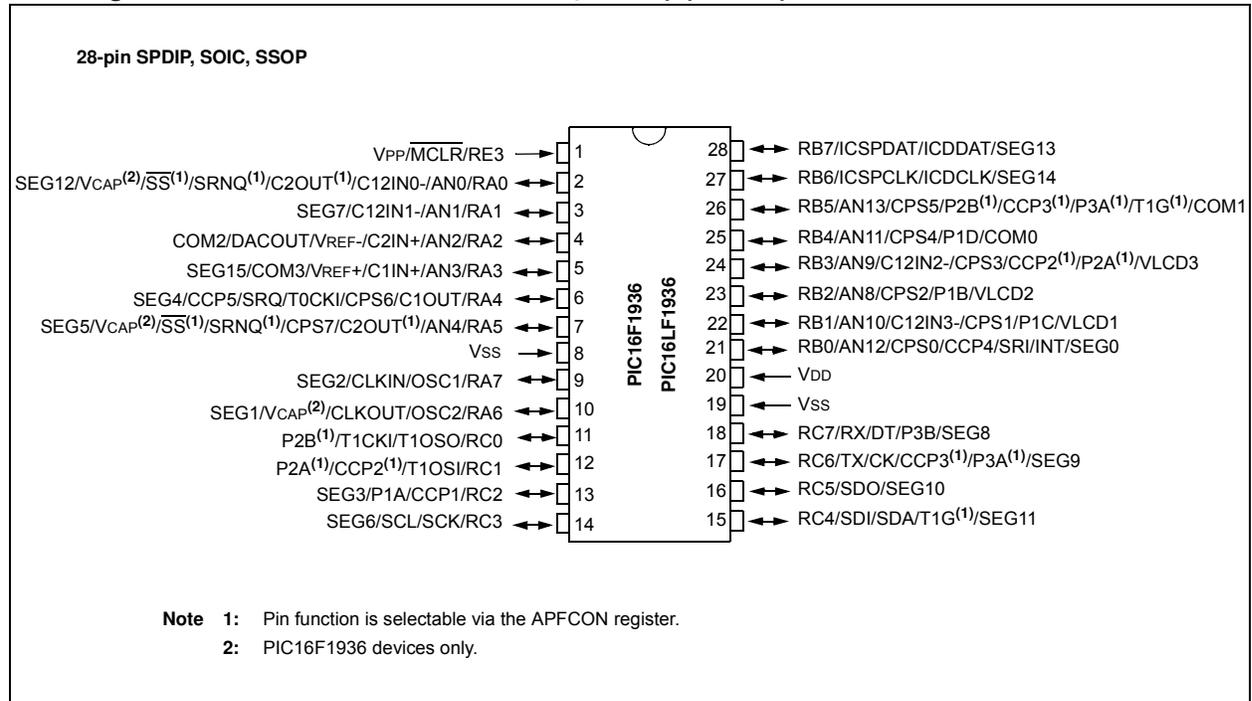
- Master Synchronous Serial Port (MSSP) with SPI and I<sup>2</sup>C™ with:
  - 7-bit address masking
  - SMBus/PMBus™ compatibility
  - Auto-wake-up on start
- Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART)
  - RS-232, RS-485 and LIN compatible
  - Auto-Baud Detect
- SR Latch (555 Timer):
  - Multiple Set/Reset input options
  - Emulates 555 Timer applications
- 2 Comparators:
  - Rail-to-rail inputs/outputs
  - Power mode control
  - Software enable hysteresis
- Voltage Reference module:
  - Fixed Voltage Reference (FVR) with 1.024V, 2.048V and 4.096V output levels
  - 5-bit rail-to-rail resistive DAC with positive and negative reference selection

## PIC16(L)F193X Family Types

Device	Program Memory Flash (words)	Data EEPROM (bytes)	SRAM (bytes)	I/O's	10-bit A/D (ch)	CapSense (ch)	Comparators	Timers 8/16-bit	EUSART	I <sup>2</sup> C™/SPI	ECCP	CCP	LCD
PIC16F1934 PIC16LF1934	4096	256	256	36	14	16	2	4/1	Yes	Yes	3	2	24/4
PIC16F1936 PIC16LF1936	8192	256	512	25	11	8	2	4/1	Yes	Yes	3	2	16 <sup>(1)</sup> /4
PIC16F1937 PIC16LF1937	8192	256	512	36	14	16	2	4/1	Yes	Yes	3	2	24/4

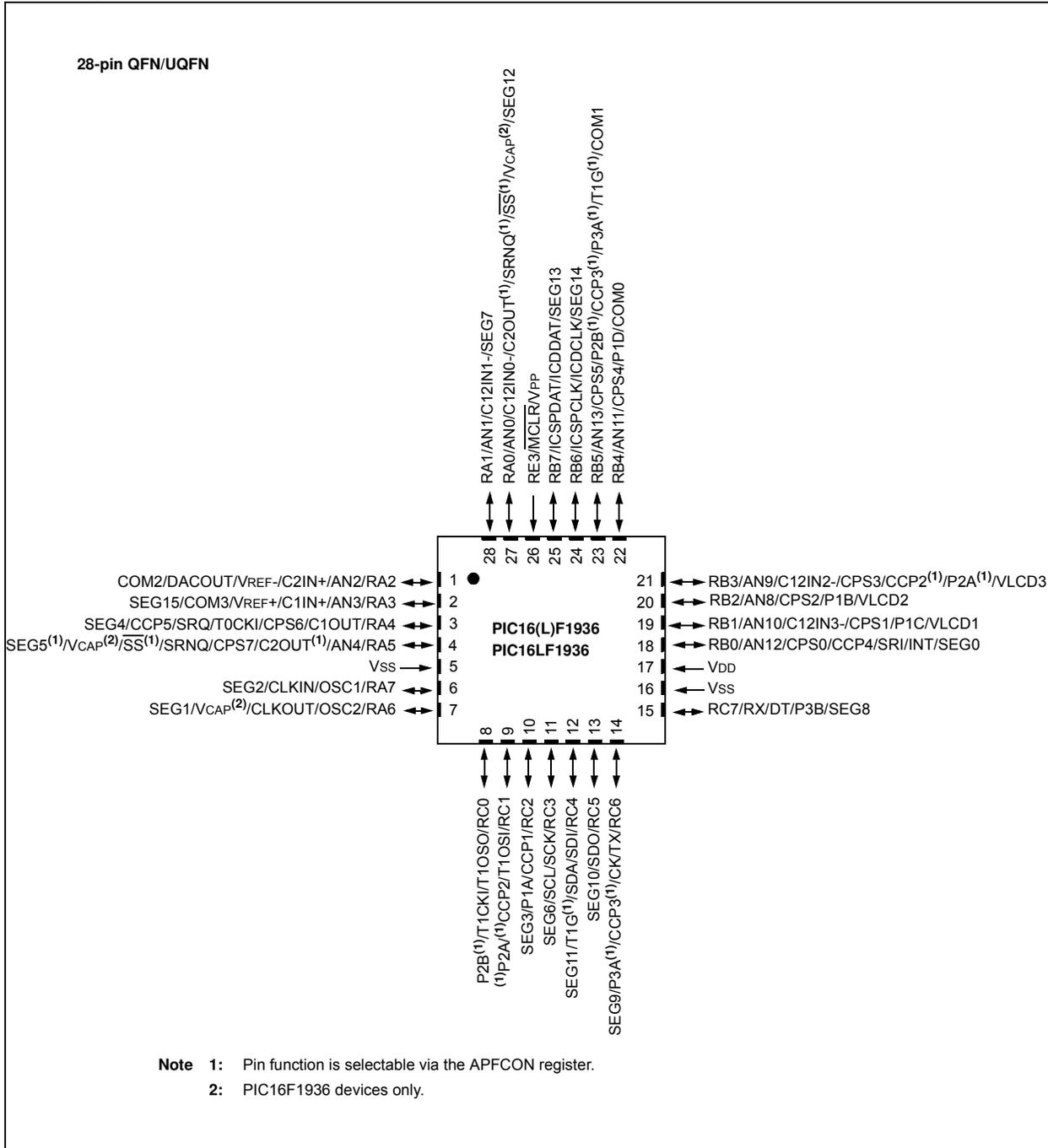
**Note 1:** COM3 and SEG15 share the same physical pin on PIC16(L)F1936, therefore, SEG15 is not available when using 1/4 multiplex displays.

## Pin Diagram – 28-Pin SPDIP/SOIC/SSOP (PIC16(L)F1936)



# PIC16(L)F1934/6/7

## Pin Diagram – 28-Pin QFN/UQFN (PIC16(L)F1936)



# PIC16(L)F1934/6/7

**TABLE 1: 28-PIN SUMMARY (PIC16(L)F1936)**

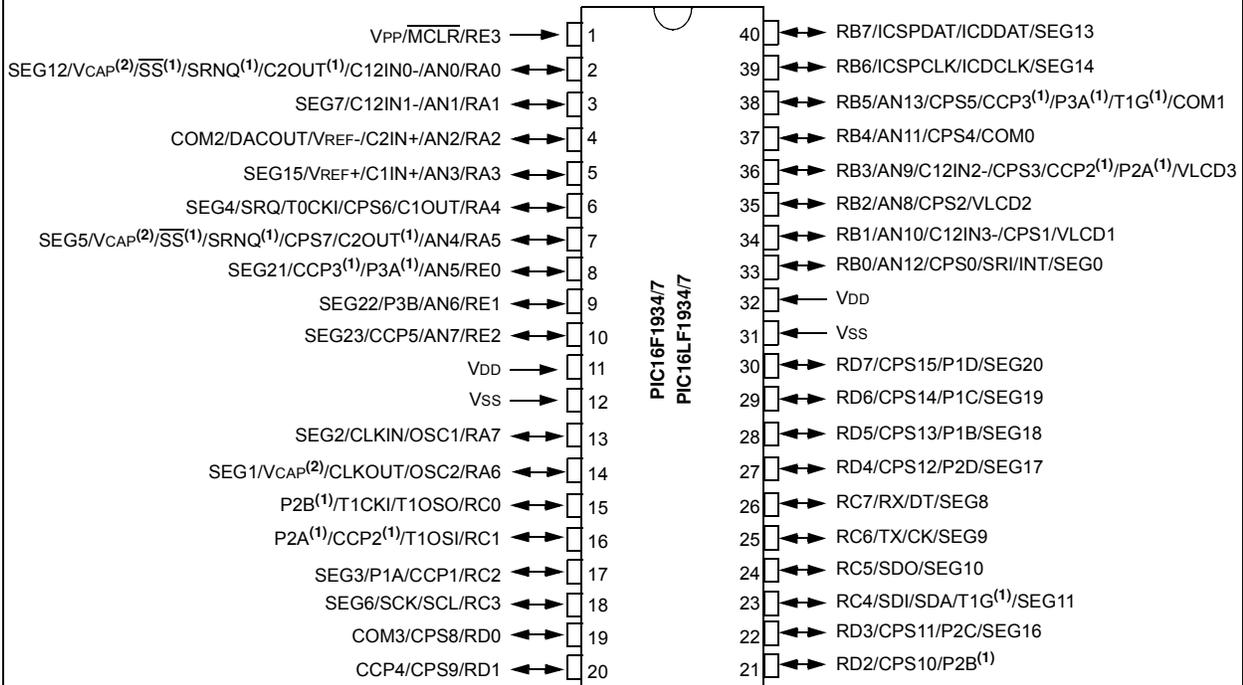
I/O	28-Pin SPDIP	28-Pin QFN/UQFN	ANSEL	A/D	Cap Sense	Comparator	SR Latch	Timers	CCP	EUSART	MSSP	LCD	Interrupt	Pull-up	Basic
RA0	2	27	Y	AN0	—	C12IN0-/C2OUT <sup>(1)</sup>	SRNQ <sup>(1)</sup>	—	—	—	SS <sup>(1)</sup>	SEG12	—	—	VCAP <sup>(2)</sup>
RA1	3	28	Y	AN1	—	C12IN1-	—	—	—	—	—	SEG7	—	—	—
RA2	4	1	Y	AN2/VREF-	—	C2IN+/ DACOUT	—	—	—	—	—	COM2	—	—	—
RA3	5	2	Y	AN3/ VREF+	—	C1IN+	—	—	—	—	—	SEG15/ COM3	—	—	—
RA4	6	3	Y	—	CPS6	C1OUT	SRQ	T0CKI	CCP5	—	—	SEG4	—	—	—
RA5	7	4	Y	AN4	CPS7	C2OUT <sup>(1)</sup>	SRNQ <sup>(1)</sup>	—	—	—	SS <sup>(1)</sup>	SEG5	—	—	VCAP <sup>(2)</sup>
RA6	10	7	—	—	—	—	—	—	—	—	—	SEG1	—	—	OSC2/ CLKOUT VCAP <sup>(2)</sup>
RA7	9	6	—	—	—	—	—	—	—	—	—	SEG2	—	—	OSC1/ CLKIN
RB0	21	18	Y	AN12	CPS0	—	SRI	—	CCP4	—	—	SEG0	INT/ IOC	Y	—
RB1	22	19	Y	AN10	CPS1	C12IN3-	—	—	P1C	—	—	VLCD1	IOC	Y	—
RB2	23	20	Y	AN8	CPS2	—	—	—	P1B	—	—	VLCD2	IOC	Y	—
RB3	24	21	Y	AN9	CPS3	C12IN2-	—	—	CCP2 <sup>(1)</sup> / P2A <sup>(1)</sup>	—	—	VLCD3	IOC	Y	—
RB4	25	22	Y	AN11	CPS4	—	—	—	P1D	—	—	COM0	IOC	Y	—
RB5	26	23	Y	AN13	CPS5	—	—	T1G <sup>(1)</sup>	P2B <sup>(1)</sup> / CCP3 <sup>(1)</sup> / P3A <sup>(1)</sup>	—	—	COM1	IOC	Y	—
RB6	27	24	—	—	—	—	—	—	—	—	—	SEG14	IOC	Y	ICSPCLK/ ICDCLK
RB7	28	25	—	—	—	—	—	—	—	—	—	SEG13	IOC	Y	ICSPDAT/ ICDDAT
RC0	11	8	—	—	—	—	—	T1OSO/ T1CKI	P2B <sup>(1)</sup>	—	—	—	—	—	—
RC1	12	9	—	—	—	—	—	T1OSI	CCP2 <sup>(1)</sup> / P2A <sup>(1)</sup>	—	—	—	—	—	—
RC2	13	10	—	—	—	—	—	—	CCP1/ P1A	—	—	SEG3	—	—	—
RC3	14	11	—	—	—	—	—	—	—	—	SCK/SCL	SEG6	—	—	—
RC4	15	12	—	—	—	—	—	T1G <sup>(1)</sup>	—	—	SDI/SDA	SEG11	—	—	—
RC5	16	13	—	—	—	—	—	—	—	—	SDO	SEG10	—	—	—
RC6	17	14	—	—	—	—	—	—	CCP3 <sup>(1)</sup> / P3A <sup>(1)</sup>	TX/CK	—	SEG9	—	—	—
RC7	18	15	—	—	—	—	—	—	P3B	RX/DT	—	SEG8	—	—	—
RE3	1	26	—	—	—	—	—	—	—	—	—	—	—	Y	MCLR/VPP
VDD	20	17	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	8, 19	5, 16	—	—	—	—	—	—	—	—	—	—	—	—	VSS

**Note** 1: Pin functions can be moved using the APFCON register.  
 2: PIC16F1936 devices only.

# PIC16(L)F1934/6/7

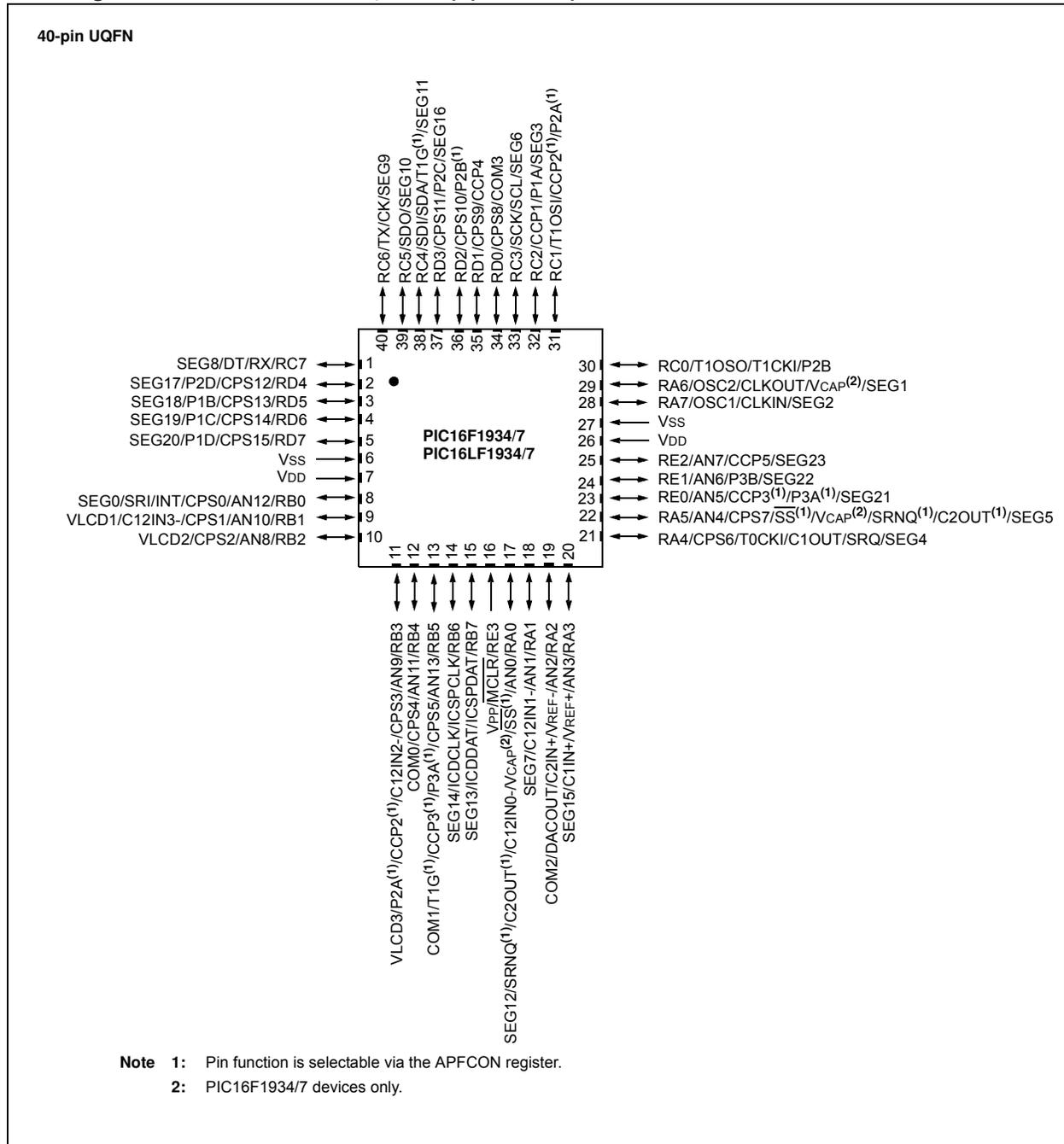
## Pin Diagram – 40-Pin PDIP (PIC16(L)F1934/7)

### 40-Pin PDIP



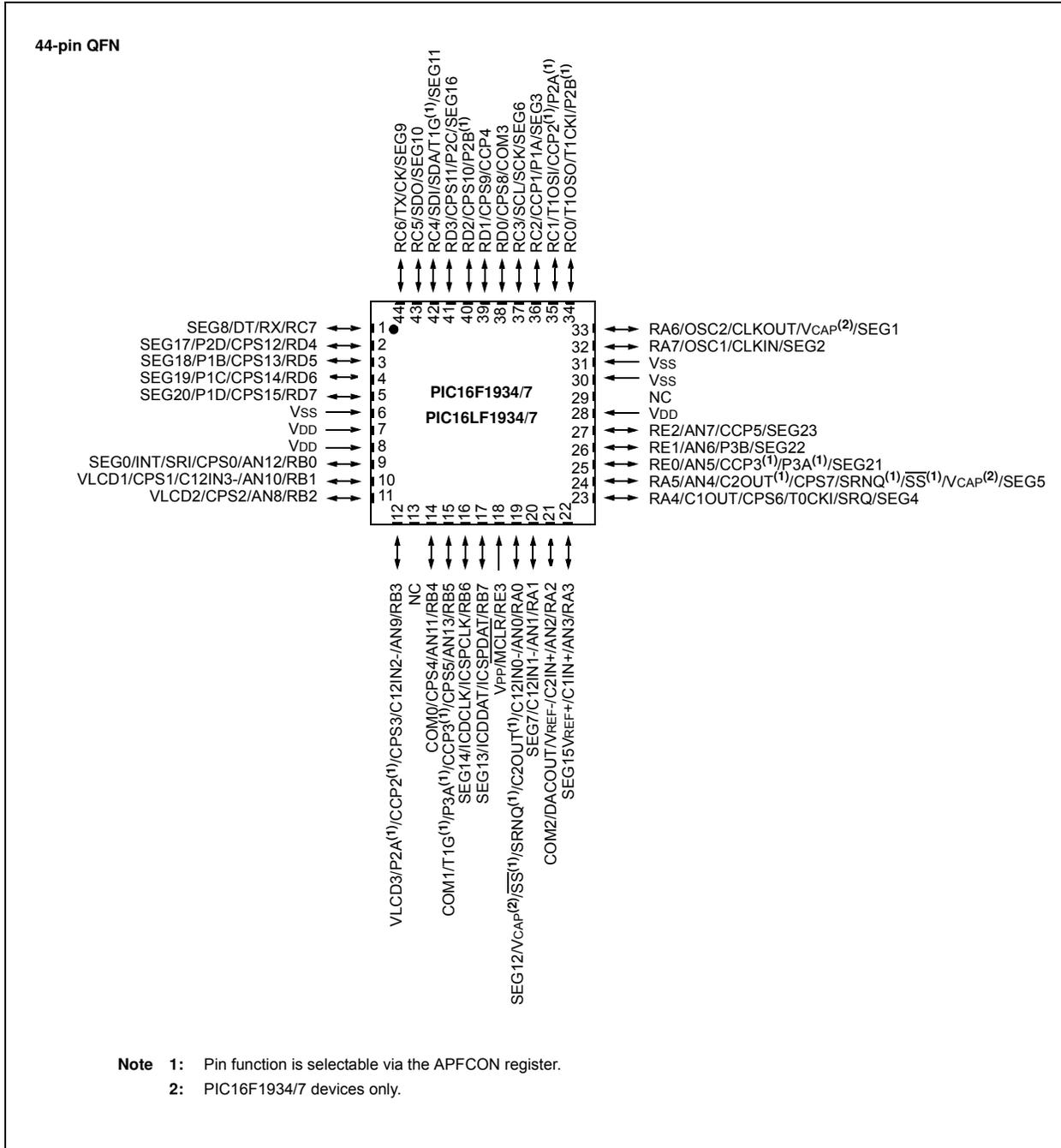
- Note 1:** Pin function is selectable via the APFCON register.  
**Note 2:** PIC16F1934/7 devices only.

## Pin Diagram – 40-Pin UQFN 5X5 (PIC16(L)F1934/7)

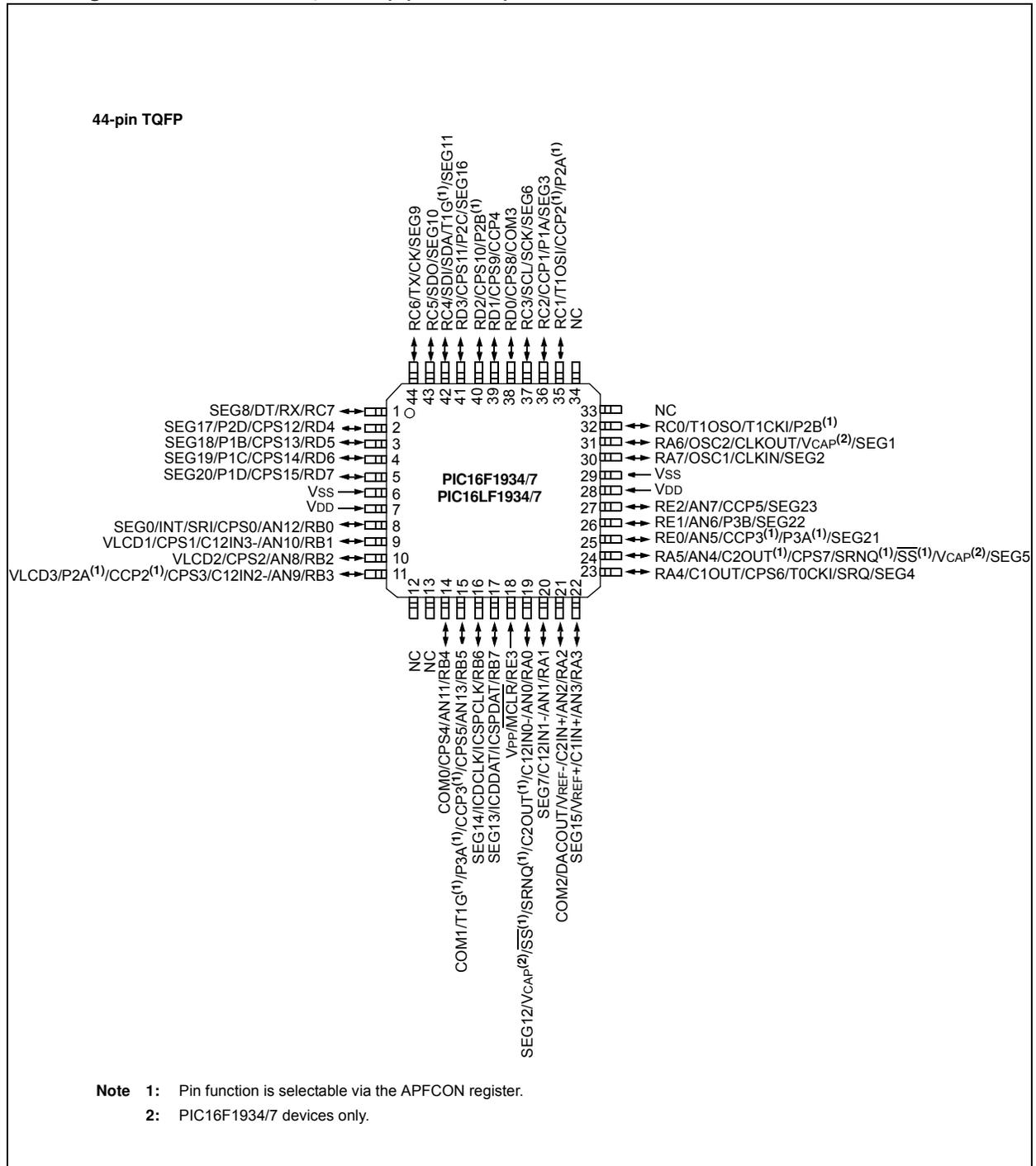


# PIC16(L)F1934/6/7

## Pin Diagram – 44-Pin QFN (PIC16(L)F1934/7)



## Pin Diagram – 44-Pin TQFP (PIC16(L)F1934/7)



# PIC16(L)F1934/6/7

**TABLE 2: 40/44-PIN SUMMARY(PIC16(L)F1934/7)**

I/O	40-Pin PDIP	40-Pin UQFN	44-Pin TQFP	44-Pin QFN	ANSEL	A/D	Cap Sense	Comparator	SR Latch	Timers	CCP	EUSART	MSSP	LCD	Interrupt	Pull-up	Basic
RA0	2	17	19	19	Y	AN0	—	C12IN0-/C2OUT <sup>(1)</sup>	SRNQ <sup>(1)</sup>	—	—	—	SS <sup>(1)</sup>	SEG12	—	—	VCAP
RA1	3	18	20	20	Y	AN1	—	C12IN1-	—	—	—	—	—	SEG7	—	—	—
RA2	4	19	21	21	Y	AN2/ VREF-	—	C2IN+/ DACOUT	—	—	—	—	—	COM2	—	—	—
RA3	5	20	22	22	Y	AN3/ VREF+	—	C1IN+	—	—	—	—	—	SEG15	—	—	—
RA4	6	21	23	23	Y	—	CPS6	C1OUT	SRQ	T0CKI	—	—	—	SEG4	—	—	—
RA5	7	22	24	24	Y	AN4	CPS7	C2OUT <sup>(1)</sup>	SRNQ <sup>(1)</sup>	—	—	—	SS <sup>(1)</sup>	SEG5	—	—	VCAP
RA6	14	29	31	33	—	—	—	—	—	—	—	—	—	SEG1	—	—	OSC2/ CLKOUT VCAP
RA7	13	28	30	32	—	—	—	—	—	—	—	—	—	SEG2	—	—	OSC1/ CLKIN
RB0	33	8	8	9	Y	AN12	CPS0	—	SRI	—	—	—	—	SEG0	INT/ IOC	Y	—
RB1	34	9	9	10	Y	AN10	CPS1	C12IN3-	—	—	—	—	—	VLCD1	IOC	Y	—
RB2	35	10	10	11	Y	AN8	CPS2	—	—	—	—	—	—	VLCD2	IOC	Y	—
RB3	36	11	11	12	Y	AN9	CPS3	C12IN2-	—	—	CCP2 <sup>(1)</sup> / P2A <sup>(1)</sup>	—	—	VLCD3	IOC	Y	—
RB4	37	12	14	14	Y	AN11	CPS4	—	—	—	—	—	—	COM0	IOC	Y	—
RB5	38	13	15	15	Y	AN13	CPS5	—	—	T1G <sup>(1)</sup>	CCP3 <sup>(1)</sup> / P3A <sup>(1)</sup>	—	—	COM1	IOC	Y	—
RB6	39	14	16	16	—	—	—	—	—	—	—	—	—	SEG14	IOC	Y	ICSPCLK/ ICDCLK
RB7	40	15	17	17	—	—	—	—	—	—	—	—	—	SEG13	IOC	Y	ICSPDAT/ ICDDAT
RC0	15	30	32	34	—	—	—	—	—	T1OSO/ T1CKI	P2B <sup>(1)</sup>	—	—	—	—	—	—
RC1	16	31	35	35	—	—	—	—	—	T1OSI	CCP2 <sup>(1)</sup> / P2A <sup>(1)</sup>	—	—	—	—	—	—
RC2	17	32	36	36	—	—	—	—	—	—	CCP1/ P1A	—	—	SEG3	—	—	—
RC3	18	33	37	37	—	—	—	—	—	—	—	—	SCK/SCL	SEG6	—	—	—
RC4	23	38	42	42	—	—	—	—	—	T1G <sup>(1)</sup>	—	—	SDI/SDA	SEG11	—	—	—
RC5	24	39	43	43	—	—	—	—	—	—	—	—	SDO	SEG10	—	—	—
RC6	25	40	44	44	—	—	—	—	—	—	—	—	TX/CK	SEG9	—	—	—
RC7	26	1	1	1	—	—	—	—	—	—	—	—	RX/DT	SEG8	—	—	—
RD0	19	34	38	38	Y	—	CPS8	—	—	—	—	—	—	COM3	—	—	—
RD1	20	35	39	39	Y	—	CPS9	—	—	—	CCP4	—	—	—	—	—	—
RD2	21	36	40	40	Y	—	CPS10	—	—	—	P2B <sup>(1)</sup>	—	—	—	—	—	—
RD3	22	37	41	41	Y	—	CPS11	—	—	—	P2C	—	—	SEG16	—	—	—
RD4	27	2	2	2	Y	—	CPS12	—	—	—	P2D	—	—	SEG17	—	—	—
RD5	28	3	3	3	Y	—	CPS13	—	—	—	P1B	—	—	SEG18	—	—	—
RD6	29	4	4	4	Y	—	CPS14	—	—	—	P1C	—	—	SEG19	—	—	—
RD7	30	5	5	5	Y	—	CPS15	—	—	—	P1D	—	—	SEG20	—	—	—
RE0	8	23	25	25	Y	AN5	—	—	—	—	CCP3 <sup>(1)</sup> / P3A <sup>(1)</sup>	—	—	SEG21	—	—	—
RE1	9	24	26	26	Y	AN6	—	—	—	—	P3B	—	—	SEG22	—	—	—
RE2	10	25	27	27	Y	AN7	—	—	—	—	CCP5	—	—	SEG23	—	—	—
RE3	1	16	18	18	—	—	—	—	—	—	—	—	—	—	Y	—	MCLR/VPP
VDD	11, 32	7, 26	7, 28	7,8, 28	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	12, 31	6, 27	6, 29	6,30, 31	—	—	—	—	—	—	—	—	—	—	—	—	VSS

**Note 1:** Pin functions can be moved using the APFCON register.

## Table of Contents

1.0	Device Overview .....	15
2.0	Enhanced Mid-Range CPU .....	23
3.0	Memory Organization .....	25
4.0	Device Configuration .....	61
5.0	Oscillator Module (With Fail-Safe Clock Monitor).....	67
6.0	Resets .....	85
7.0	Interrupts .....	93
8.0	Low Dropout (LDO) Voltage Regulator .....	107
9.0	Power-Down Mode (Sleep) .....	109
10.0	Watchdog Timer (WDT) .....	111
11.0	Data EEPROM and Flash Program Memory Control .....	115
12.0	I/O Ports .....	129
13.0	Interrupt-On-Change .....	151
14.0	Fixed Voltage Reference .....	155
15.0	Analog-to-Digital Converter (ADC) Module .....	157
16.0	Temperature Indicator Module .....	171
17.0	Digital-to-Analog Converter (DAC) Module .....	173
18.0	Comparator Module.....	177
19.0	SR Latch.....	187
20.0	Timer0 Module .....	191
21.0	Timer1 Module with Gate Control.....	197
22.0	Timer2/4/6 Modules.....	207
23.0	Capture/Compare/PWM Modules (ECCP1, ECCP2, ECCP3, CCP4, CCP5).....	211
24.0	Master Synchronous Serial Port (MSSP) Module .....	239
25.0	Enhanced Universal Synchronous Asynchronous Receiver Transmitter (EUSART).....	291
26.0	Capacitive Sensing Module.....	319
27.0	Liquid Crystal Display (LCD) Driver Module.....	327
28.0	In-Circuit Serial Programming™ (ICSP™) .....	361
29.0	Instruction Set Summary .....	365
30.0	Electrical Specifications.....	379
31.0	DC and AC Characteristics Graphs and Charts .....	411
32.0	Development Support.....	439
33.0	Packaging Information.....	443
	Appendix A: Data Sheet Revision History.....	459
	Appendix B: Migrating From Other PIC® Devices.....	459
	Index .....	461
	The Microchip Web Site .....	469
	Customer Change Notification Service .....	469
	Customer Support .....	469
	Reader Response .....	470
	Product Identification System .....	471

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## 1.0 DEVICE OVERVIEW

The PIC16(L)F1934/6/7 are described within this data sheet. They are available in 28/40/44-pin packages. [Figure 1-1](#) shows a block diagram of the PIC16(L)F1934/6/7 devices. [Table 1-2](#) shows the pinout descriptions.

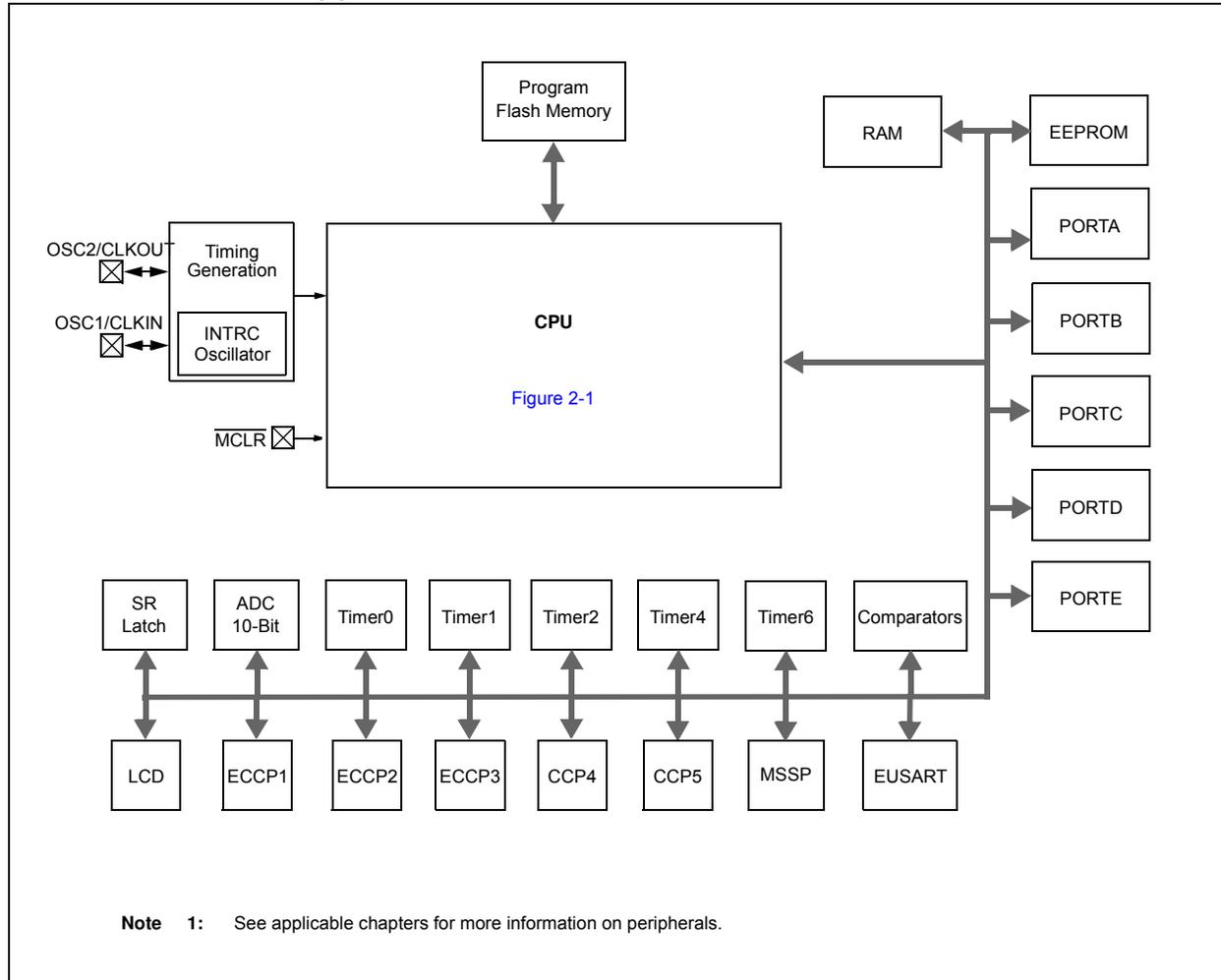
Reference [Table 1-1](#) for peripherals available per device.

**TABLE 1-1: DEVICE PERIPHERAL SUMMARY**

Peripheral		PIC16F193X	PIC16LF193X
ADC		•	•
Capacitive Sensing Module		•	•
Digital-to-Analog Converter (DAC)		•	•
EUSART		•	•
Fixed Voltage Reference (FVR)		•	•
LCD		•	•
SR Latch		•	•
Temperature Indicator		•	•
Capture/Compare/PWM Modules			
	ECCP1	•	•
	ECCP2	•	•
	ECCP3	•	•
	CCP4	•	•
	CCP5	•	•
Comparators			
	C1	•	•
	C2	•	•
Operational Amplifiers			
	OPA1	•	•
	OPA2	•	•
Master Synchronous Serial Ports			
	MSSP1	•	•
Timers			
	Timer0	•	•
	Timer1	•	•
	Timer2	•	•
	Timer4	•	•
	Timer6	•	•

# PIC16(L)F1934/6/7

FIGURE 1-1: PIC16(L)F1934/6/7 BLOCK DIAGRAM



# PIC16(L)F1934/6/7

**TABLE 1-2: PIC16(L)F1934/6/7 PINOUT DESCRIPTION**

Name	Function	Input Type	Output Type	Description
RA0/AN0/C12IN0-/C2OUT <sup>(1)</sup> /SRNQ <sup>(1)</sup> /SS <sup>(1)</sup> /VCAP <sup>(2)</sup> /SEG12	RA0	TTL	CMOS	General purpose I/O.
	AN0	AN	—	A/D Channel 0 input.
	C12IN0-	AN	—	Comparator C1 or C2 negative input.
	C2OUT	—	CMOS	Comparator C2 output.
	SRNQ	—	CMOS	SR Latch inverting output.
	SS	ST	—	Slave Select input.
	VCAP	Power	Power	Filter capacitor for Voltage Regulator (PIC16F1934/6/7 only).
RA1/AN1/C12IN1-/SEG7	RA1	TTL	CMOS	General purpose I/O.
	AN1	AN	—	A/D Channel 1 input.
	C12IN1-	AN	—	Comparator C1 or C2 negative input.
	SEG7	—	AN	LCD Analog output.
RA2/AN2/C2IN+/VREF-/DACOUT/COM2	RA2	TTL	CMOS	General purpose I/O.
	AN2	AN	—	A/D Channel 2 input.
	C2IN+	AN	—	Comparator C2 positive input.
	VREF-	AN	—	A/D Negative Voltage Reference input.
	DACOUT	—	AN	Voltage Reference output.
RA3/AN3/C1IN+/VREF+/COM3 <sup>(3)</sup> /SEG15	RA3	TTL	CMOS	General purpose I/O.
	AN3	AN	—	A/D Channel 3 input.
	C1IN+	AN	—	Comparator C1 positive input.
	VREF+	AN	—	A/D Voltage Reference input.
	COM3 <sup>(3)</sup>	—	AN	LCD Analog output.
	SEG15	—	AN	LCD Analog output.
RA4/C1OUT/CPS6/T0CKI/SRQ/CCP5/SEG4	RA4	TTL	CMOS	General purpose I/O.
	C1OUT	—	CMOS	Comparator C1 output.
	CPS6	AN	—	Capacitive sensing input 6.
	T0CKI	ST	—	Timer0 clock input.
	SRQ	—	CMOS	SR Latch non-inverting output.
	CCP5	ST	CMOS	Capture/Compare/PWM5.
RA5/AN4/C2OUT <sup>(1)</sup> /CPS7/SRNQ <sup>(1)</sup> /SS <sup>(1)</sup> /VCAP <sup>(2)</sup> /SEG5	RA5	TTL	CMOS	General purpose I/O.
	AN4	AN	—	A/D Channel 4 input.
	C2OUT	—	CMOS	Comparator C2 output.
	CPS7	AN	—	Capacitive sensing input 7.
	SRNQ	—	CMOS	SR Latch inverting output.
	SS	ST	—	Slave Select input.
	VCAP	Power	Power	Filter capacitor for Voltage Regulator (PIC16F1934/6/7 only).
SEG5	—	AN	LCD Analog output.	

**Legend:** AN = Analog input or output    CMOS = CMOS compatible input or output    OD = Open Drain  
TTL = TTL compatible input    ST = Schmitt Trigger input with CMOS levels    I<sup>2</sup>C™ = Schmitt Trigger input with I<sup>2</sup>C levels  
HV = High Voltage    XTAL = Crystal

- Note** 1: Pin function is selectable via the APFCON register.  
2: PIC16F1934/6/7 devices only.  
3: PIC16(L)F1936 devices only.  
4: PORTD is available on PIC16(L)F1934/7 devices only.  
5: RE<2:0> are available on PIC16(L)F1934/7 devices only.

# PIC16(L)F1934/6/7

**TABLE 1-2: PIC16(L)F1934/6/7 PINOUT DESCRIPTION (CONTINUED)**

Name	Function	Input Type	Output Type	Description
RA6/OSC2/CLKOUT/VCAP <sup>(2)</sup> /SEG1	RA6	TTL	CMOS	General purpose I/O.
	OSC2	—	XTAL	Crystal/Resonator (LP, XT, HS modes).
	CLKOUT	—	CMOS	Fosc/4 output.
	VCAP	Power	Power	Filter capacitor for Voltage Regulator (PIC16F1934/6/7 only).
	SEG1	—	AN	LCD Analog output.
RA7/OSC1/CLKIN/SEG2	RA7	TTL	CMOS	General purpose I/O.
	OSC1	XTAL	—	Crystal/Resonator (LP, XT, HS modes).
	CLKIN	CMOS	—	External clock input (EC mode).
	SEG2	—	AN	LCD Analog output.
RB0/AN12/CPS0/CCP4/SRI/INT/SEG0	RB0	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN12	AN	—	A/D Channel 12 input.
	CPS0	AN	—	Capacitive sensing input 0.
	CCP4	ST	CMOS	Capture/Compare/PWM4.
	SRI	—	ST	SR Latch input.
	INT	ST	—	External interrupt.
	SEG0	—	AN	LCD analog output.
RB1/AN10/C12IN3-/CPS1/P1C/VLCD1	RB1	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN10	AN	—	A/D Channel 10 input.
	C12IN3-	AN	—	Comparator C1 or C2 negative input.
	CPS1	AN	—	Capacitive sensing input 1.
	P1C	—	CMOS	PWM output.
	VLCD1	AN	—	LCD analog input.
RB2/AN8/CPS2/P1B/VLCD2	RB2	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN8	AN	—	A/D Channel 8 input.
	CPS2	AN	—	Capacitive sensing input 2.
	P1B	—	CMOS	PWM output.
	VLCD2	AN	—	LCD analog input.
RB3/AN9/C12IN2-/CPS3/CCP2 <sup>(1)</sup> /P2A <sup>(1)</sup> /VLCD3	RB3	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN9	AN	—	A/D Channel 9 input.
	C12IN2-	AN	—	Comparator C1 or C2 negative input.
	CPS3	AN	—	Capacitive sensing input 3.
	CCP2	ST	CMOS	Capture/Compare/PWM2.
	P2A	—	CMOS	PWM output.
	VLCD3	AN	—	LCD analog input.

**Legend:** AN = Analog input or output    CMOS = CMOS compatible input or output    OD = Open Drain  
TTL = TTL compatible input    ST = Schmitt Trigger input with CMOS levels    I<sup>2</sup>C™ = Schmitt Trigger input with I<sup>2</sup>C levels  
HV = High Voltage    XTAL = Crystal

- Note** 1: Pin function is selectable via the APFCON register.  
2: PIC16F1934/6/7 devices only.  
3: PIC16(L)F1936 devices only.  
4: PORTD is available on PIC16(L)F1934/7 devices only.  
5: RE<2:0> are available on PIC16(L)F1934/7 devices only.

# PIC16(L)F1934/6/7

**TABLE 1-2: PIC16(L)F1934/6/7 PINOUT DESCRIPTION (CONTINUED)**

Name	Function	Input Type	Output Type	Description
RB4/AN11/CPS4/P1D/COM0	RB4	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN11	AN	—	A/D Channel 11 input.
	CPS4	AN	—	Capacitive sensing input 4.
	P1D	—	CMOS	PWM output.
	COM0	—	AN	LCD Analog output.
RB5/AN13/CPS5/P2B/CCP3 <sup>(1)</sup> /P3A <sup>(1)</sup> /T1G <sup>(1)</sup> /COM1	RB5	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	AN13	AN	—	A/D Channel 13 input.
	CPS5	AN	—	Capacitive sensing input 5.
	P2B	—	CMOS	PWM output.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	P3A	—	CMOS	PWM output.
	T1G	ST	—	Timer1 Gate input.
RB6/ICSPCLK/ICDCLK/SEG14	RB6	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	ICSPCLK	ST	—	Serial Programming Clock.
	ICDCLK	ST	—	In-Circuit Debug Clock.
	SEG14	—	AN	LCD Analog output.
RB7/ICSPDAT/ICDDAT/SEG13	RB7	TTL	CMOS	General purpose I/O. Individually controlled interrupt-on-change. Individually enabled pull-up.
	ICSPDAT	ST	CMOS	ICSP™ Data I/O.
	ICDDAT	ST	CMOS	In-Circuit Data I/O.
	SEG13	—	AN	LCD Analog output.
RC0/T1OSO/T1CKI/P2B <sup>(1)</sup>	RC0	ST	CMOS	General purpose I/O.
	T1OSO	XTAL	XTAL	Timer1 oscillator connection.
	T1CKI	ST	—	Timer1 clock input.
	P2B	—	CMOS	PWM output.
RC1/T1OSI/CCP2 <sup>(1)</sup> /P2A <sup>(1)</sup>	RC1	ST	CMOS	General purpose I/O.
	T1OSI	XTAL	XTAL	Timer1 oscillator connection.
	CCP2	ST	CMOS	Capture/Compare/PWM2.
	P2A	—	CMOS	PWM output.
RC2/CCP1/P1A/SEG3	RC2	ST	CMOS	General purpose I/O.
	CCP1	ST	CMOS	Capture/Compare/PWM1.
	P1A	—	CMOS	PWM output.
	SEG3	—	AN	LCD Analog output.
RC3/SCK/SCL/SEG6	RC3	ST	CMOS	General purpose I/O.
	SCK	ST	CMOS	SPI clock.
	SCL	I <sup>2</sup> C	OD	I <sup>2</sup> C™ clock.
	SEG6	—	AN	LCD Analog output.

**Legend:** AN = Analog input or output    CMOS = CMOS compatible input or output    OD = Open Drain  
TTL = TTL compatible input    ST = Schmitt Trigger input with CMOS levels    I<sup>2</sup>C™ = Schmitt Trigger input with I<sup>2</sup>C levels  
HV = High Voltage    XTAL = Crystal

- Note** 1: Pin function is selectable via the APFCON register.  
2: PIC16F1934/6/7 devices only.  
3: PIC16(L)F1936 devices only.  
4: PORTD is available on PIC16(L)F1934/7 devices only.  
5: RE<2:0> are available on PIC16(L)F1934/7 devices only.

# PIC16(L)F1934/6/7

**TABLE 1-2: PIC16(L)F1934/6/7 PINOUT DESCRIPTION (CONTINUED)**

Name	Function	Input Type	Output Type	Description
RC4/SDI/SDA/T1G <sup>(1)</sup> /SEG11	RC4	ST	CMOS	General purpose I/O.
	SDI	ST	—	SPI data input.
	SDA	I <sup>2</sup> C	OD	I <sup>2</sup> C™ data input/output.
	T1G	ST	—	Timer1 Gate input.
	SEG11	—	AN	LCD Analog output.
RC5/SDO/SEG10	RC5	ST	CMOS	General purpose I/O.
	SDO	—	CMOS	SPI data output.
	SEG10	—	AN	LCD Analog output.
RC6/TX/CK/CCP3/P3A/SEG9	RC6	ST	CMOS	General purpose I/O.
	TX	—	CMOS	USART asynchronous transmit.
	CK	ST	CMOS	USART synchronous clock.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	P3A	—	CMOS	PWM output.
	SEG9	—	AN	LCD Analog output.
RC7/RX/DT/P3B/SEG8	RC7	ST	CMOS	General purpose I/O.
	RX	ST	—	USART asynchronous input.
	DT	ST	CMOS	USART synchronous data.
	P3B	—	CMOS	PWM output.
	SEG8	—	AN	LCD Analog output.
RD0 <sup>(4)</sup> /CPS8/COM3	RD0	ST	CMOS	General purpose I/O.
	CPS8	AN	—	Capacitive sensing input 8.
	COM3	—	AN	LCD analog output.
RD1 <sup>(4)</sup> /CPS9/CCP4	RD1	ST	CMOS	General purpose I/O.
	CPS9	AN	—	Capacitive sensing input 9.
	CCP4	ST	CMOS	Capture/Compare/PWM4.
RD2 <sup>(4)</sup> /CPS10/P2B	RD2	ST	CMOS	General purpose I/O.
	CPS10	AN	—	Capacitive sensing input 10.
	P2B	—	CMOS	PWM output.
RD3 <sup>(4)</sup> /CPS11/P2C/SEG16	RD3	ST	CMOS	General purpose I/O.
	CPS11	AN	—	Capacitive sensing input 11.
	P2C	—	CMOS	PWM output.
	SEG16	—	AN	LCD analog output.
RD4 <sup>(4)</sup> /CPS12/P2D/SEG17	RD4	ST	CMOS	General purpose I/O.
	CPS12	AN	—	Capacitive sensing input 12.
	P2D	—	CMOS	PWM output.
	SEG17	—	AN	LCD analog output.
RD5 <sup>(4)</sup> /CPS13/P1B/SEG18	RD5	ST	CMOS	General purpose I/O.
	CPS13	AN	—	Capacitive sensing input 13.
	P1D	—	CMOS	PWM output.
	SEG18	—	AN	LCD analog output.

**Legend:** AN = Analog input or output    CMOS = CMOS compatible input or output    OD = Open Drain  
TTL = TTL compatible input    ST = Schmitt Trigger input with CMOS levels    I<sup>2</sup>C™ = Schmitt Trigger input with I<sup>2</sup>C levels  
HV = High Voltage    XTAL = Crystal

- Note** 1: Pin function is selectable via the APFCON register.  
2: PIC16F1934/6/7 devices only.  
3: PIC16(L)F1936 devices only.  
4: PORTD is available on PIC16(L)F1934/7 devices only.  
5: RE<2:0> are available on PIC16(L)F1934/7 devices only.

# PIC16(L)F1934/6/7

**TABLE 1-2: PIC16(L)F1934/6/7 PINOUT DESCRIPTION (CONTINUED)**

Name	Function	Input Type	Output Type	Description
RD6 <sup>(4)</sup> /CPS14/P1C/SEG19	RD6	ST	CMOS	General purpose I/O.
	CPS14	AN	—	Capacitive sensing input 14.
	P1C	—	CMOS	PWM output.
	SEG19	—	AN	LCD analog output.
RD7 <sup>(4)</sup> /CPS15/P1D/SEG20	RD7	ST	CMOS	General purpose I/O.
	CPS15	AN	—	Capacitive sensing input 15.
	P1D	—	CMOS	PWM output.
	SEG20	—	AN	LCD analog output.
RE0 <sup>(5)</sup> /AN5/P3A <sup>(1)</sup> /CCP3 <sup>(1)</sup> /SEG21	RE0	ST	CMOS	General purpose I/O.
	AN5	AN	—	A/D Channel 5 input.
	P3A	—	CMOS	PWM output.
	CCP3	ST	CMOS	Capture/Compare/PWM3.
	SEG21	—	AN	LCD analog output.
RE1 <sup>(5)</sup> /AN6/P3B/SEG22	RE1	ST	CMOS	General purpose I/O.
	AN6	AN	—	A/D Channel 6 input.
	P3B	—	CMOS	PWM output.
	SEG22	—	AN	LCD analog output.
RE2 <sup>(5)</sup> /AN7/CCP5/SEG23	RE2	ST	CMOS	General purpose I/O.
	AN7	AN	—	A/D Channel 7 input.
	CCP5	ST	CMOS	Capture/Compare/PWM5.
	SEG23	—	AN	LCD analog output.
RE3/MCLR/VPP	RE3	TTL	—	General purpose input.
	MCLR	ST	—	Master Clear with internal pull-up.
	VPP	HV	—	Programming voltage.
VDD	VDD	Power	—	Positive supply.
VSS	VSS	Power	—	Ground reference.

**Legend:** AN = Analog input or output    CMOS = CMOS compatible input or output    OD = Open Drain  
TTL = TTL compatible input    ST = Schmitt Trigger input with CMOS levels    I<sup>2</sup>C™ = Schmitt Trigger input with I<sup>2</sup>C levels  
HV = High Voltage    XTAL = Crystal

- Note** 1: Pin function is selectable via the APFCON register.  
2: PIC16F1934/6/7 devices only.  
3: PIC16(L)F1936 devices only.  
4: PORTD is available on PIC16(L)F1934/7 devices only.  
5: RE<2:0> are available on PIC16(L)F1934/7 devices only.

# PIC16(L)F1934/6/7

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NOTES:

## 2.0 ENHANCED MID-RANGE CPU

This family of devices contain an enhanced mid-range 8-bit CPU core. The CPU has 49 instructions. Interrupt capability includes automatic context saving. The hardware stack is 16 levels deep and has Overflow and Underflow Reset capability. Direct, Indirect, and Relative Addressing modes are available. Two File Select Registers (FSRs) provide the ability to read program and data memory.

- Automatic Interrupt Context Saving
- 16-level Stack with Overflow and Underflow
- File Select Registers
- Instruction Set

### 2.1 Automatic Interrupt Context Saving

During interrupts, certain registers are automatically saved in shadow registers and restored when returning from the interrupt. This saves stack space and user code. See [Section 7.5 “Automatic Context Saving”](#), for more information.

### 2.2 16-level Stack with Overflow and Underflow

These devices have an external stack memory 15 bits wide and 16 words deep. A Stack Overflow or Underflow will set the appropriate bit (STKOVF or STKUNF) in the PCON register, and if enabled will cause a software Reset. See section [Section 3.4 “Stack”](#) for more details.

### 2.3 File Select Registers

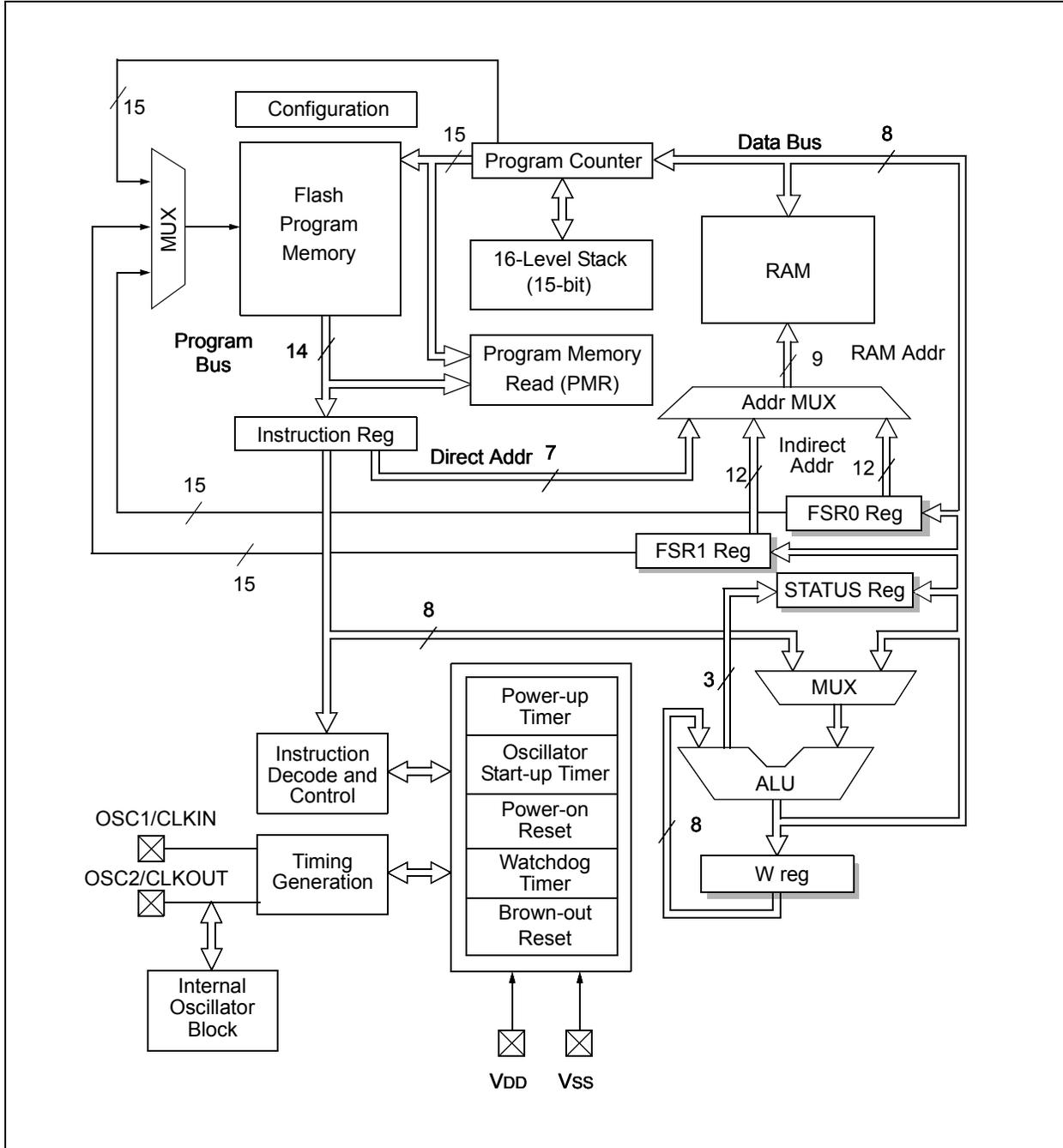
There are two 16-bit File Select Registers (FSR). FSRs can access all file registers and program memory, which allows one Data Pointer for all memory. When an FSR points to program memory, there is 1 additional instruction cycle in instructions using INDF to allow the data to be fetched. General purpose memory can now also be addressed linearly, providing the ability to access contiguous data larger than 80 bytes. There are also new instructions to support the FSRs. See [Section 3.5 “Indirect Addressing”](#) for more details.

### 2.4 Instruction Set

There are 49 instructions for the enhanced mid-range CPU to support the features of the CPU. See [Section 29.0 “Instruction Set Summary”](#) for more details.

# PIC16(L)F1934/6/7

FIGURE 2-1: CORE BLOCK DIAGRAM



## 3.0 MEMORY ORGANIZATION

There are three types of memory in PIC16(L)F1934/6/7 devices: Data Memory, Program Memory and Data EEPROM Memory<sup>(1)</sup>.

- Program Memory
- Data Memory
  - Core Registers
  - Special Function Registers
  - General Purpose RAM
  - Common RAM
  - Device Memory Maps
  - Special Function Registers Summary
- Data EEPROM memory<sup>(1)</sup>

**Note 1:** The data EEPROM memory and the method to access Flash memory through the EECON registers is described in [Section 11.0 “Data EEPROM and Flash Program Memory Control”](#).

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing

## 3.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing 32K x 14 program memory space. [Table 3-1](#) shows the memory sizes implemented for the PIC16(L)F1934/6/7 family. Accessing a location above these boundaries will cause a wrap-around within the implemented memory space. The Reset vector is at 0000h and the interrupt vector is at 0004h (see [Figures 3-1](#) and [3-2](#)).

**TABLE 3-1: DEVICE SIZES AND ADDRESSES**

Device	Program Memory Space (Words)	Last Program Memory Address
PIC16F1934/PIC16LF1934	4,096	0FFFh
PIC16F1936/PIC16LF1936	8,192	1FFFh
PIC16F1937/PIC16LF1937	8,192	1FFFh